

# PXP3R7-12QU

## 12 V, P-channel Trench MOSFET

6 September 2021 **Product data sheet**

## 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Low threshold voltage
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

## 3. Applications

- High-side load switch
- Battery management
- DC-to-DC conversion
- Switching circuits

## 4. Quick reference data

**Table 1. Quick reference data**

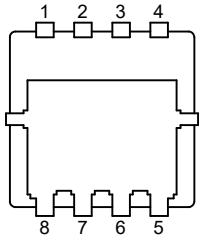
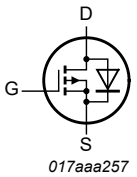
| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | - | -12 | V |
| $V_{GS}$ | gate-source voltage | | | -8 | - | 8 | V |
| $I_D$ | drain current | $V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s | [1] | - | - | -30.6 | A |
| **Static characteristics** | | | | | | | |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = -4.5 V; $I_D$ = -18.6 A; $T_j$ = 25 °C | | - | 3.2 | 3.7 | mΩ |
| | | $V_{GS}$ = -2.5 V; $I_D$ = -15.9 A; $T_j$ = 25 °C | | - | 4.1 | 5.1 | mΩ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 $cm^2$.

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## 5. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|---|---|---|---|---|
| 1 | S | source |  MLPAK33 (SOT8002-1) |  |
| 2 | S | source | | |
| 3 | S | source | | |
| 4 | G | gate | | |
| 5 | D | drain | | |
| 6 | D | drain | | |
| 7 | D | drain | | |
| 8 | D | drain | | |

## 6. Ordering information

**Table 3. Ordering information**

| Type number | Package | | |
|---|---|---|---|
| | Name | Description | Version |
| PXP3R7-12QU | MLPAK33 | plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body | SOT8002-1 |

## 7. Marking

**Table 4. Marking codes**

| Type number | Marking code |
|---|---|
| PXP3R7-12QU | 9AR |


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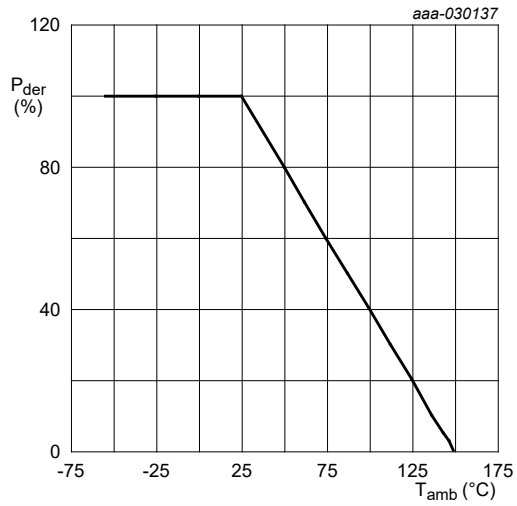
# 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

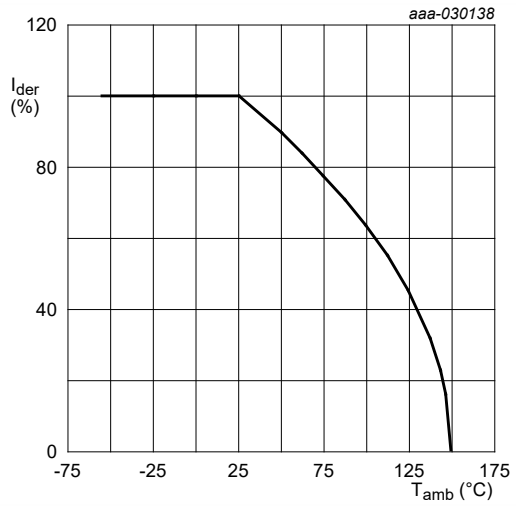
| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | -12 | V |
| $V_{GS}$ | gate-source voltage | | | -8 | 8 | V |
| $I_D$ | drain current | $V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s | [1] | - | -30.6 | A |
| | | $V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C | [1] | - | -18.7 | A |
| | | $V_{GS}$ = -4.5 V; $T_{amb}$ = 100 °C | [1] | - | -11.8 | A |
| | | $V_{GS}$ = -4.5 V; $T_{sp}$ = 25 °C | | - | -98.6 | A |
| $I_{DM}$ | peak drain current | $T_{amb}$ = 25 °C; single pulse; $t_p$ ≤ 10 µs | | - | -154 | A |
| $P_{tot}$ | total power dissipation | $T_{amb}$ = 25 °C; t ≤ 5 s | [1] | - | 4.8 | W |
| | | $T_{amb}$ = 25 °C | [1] | - | 1.8 | W |
| | | $T_{sp}$ = 25 °C | | - | 50 | W |
| $T_j$ | junction temperature | | | -55 | 150 | °C |
| $T_{amb}$ | ambient temperature | | | -55 | 150 | °C |
| $T_{stg}$ | storage temperature | | | -65 | 150 | °C |
| **Source-drain diode** | | | | | | |
| $I_S$ | source current | $T_{amb}$ = 25 °C | [1] | - | -1.7 | A |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 $cm^2$.




$$P_{der} = \frac{P_{tot}}{P_{tot\,(25\,°C)}} \times 100\,\%$$

**Fig. 1. Normalized total power dissipation as a function of ambient temperature**




$$I_{der} = \frac{I_D}{I_{D\,(25\,°C)}} \times 100\,\%$$

**Fig. 2. Normalized continous drain current as a function of ambient temperature**


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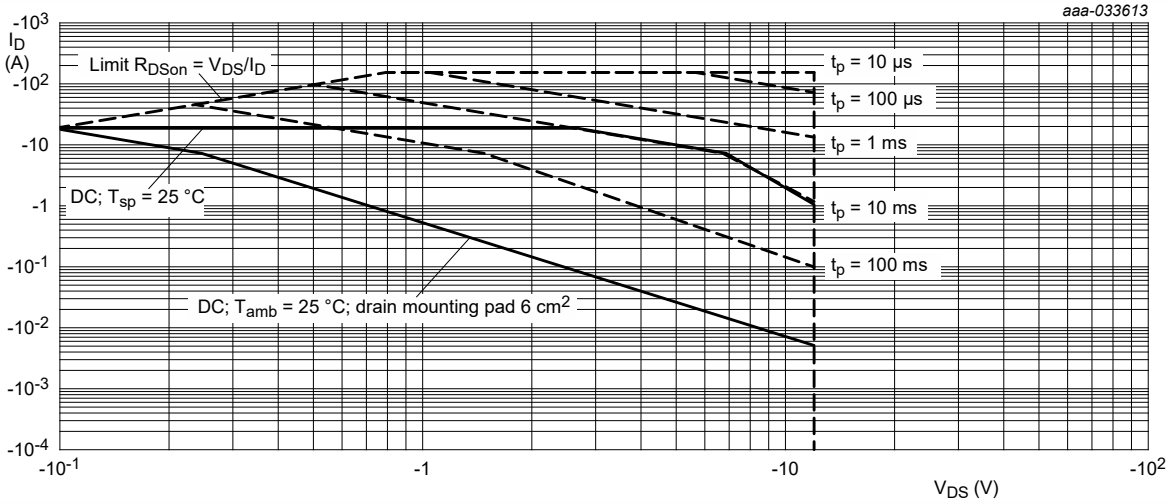



**Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage**


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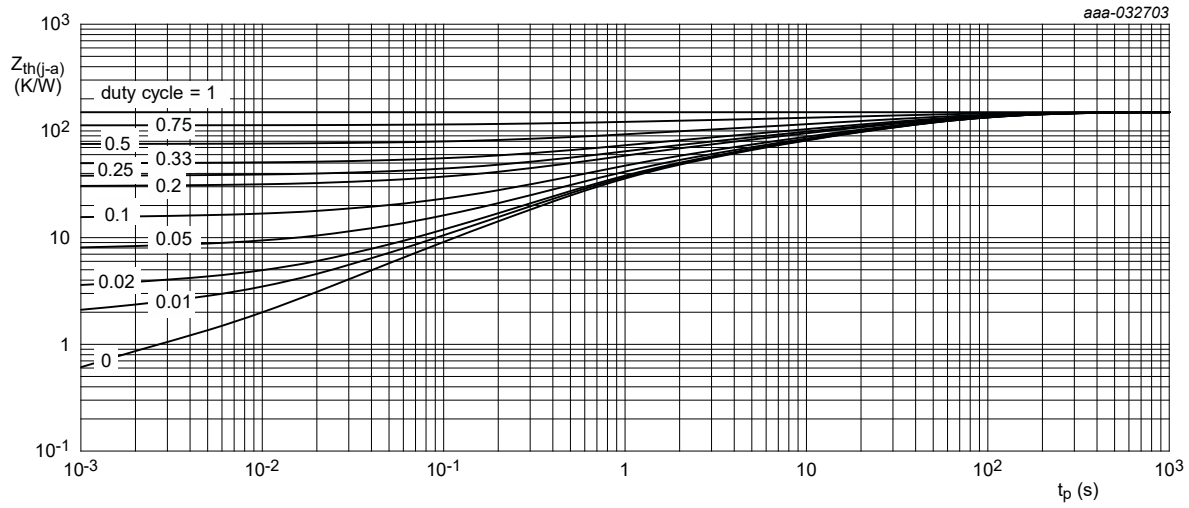
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# 9. Thermal characteristics

**Table 6. Thermal characteristics**

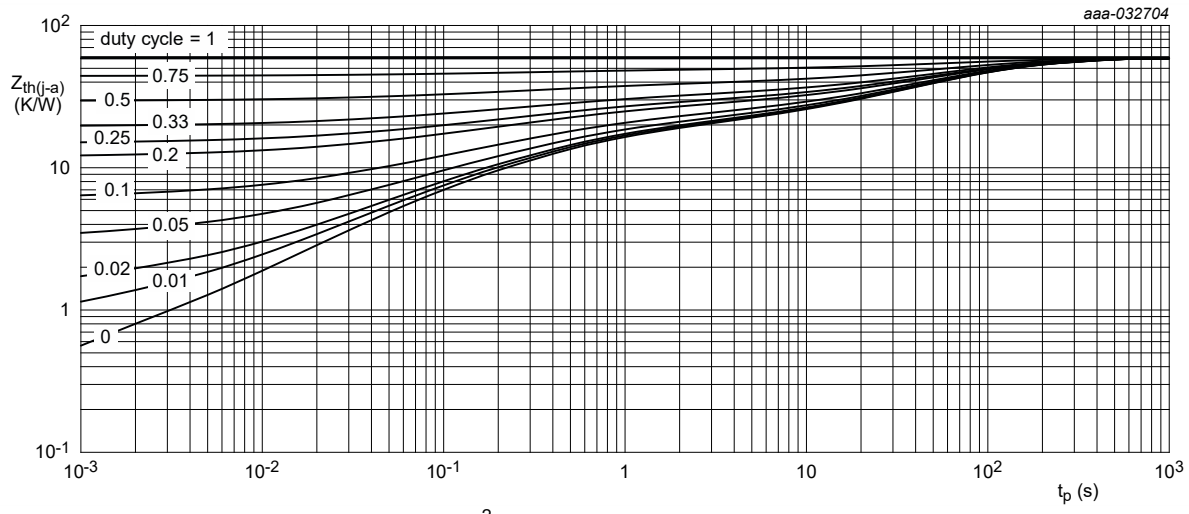
| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | 145 | 185 | K/W |
| | | | [2] | - | 55 | 70 | K/W |
| | | in free air; t ≤ 5 s | [2] | - | 21 | 26 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | - | 1.5 | 2.5 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 $cm^2$.




FR4 PCB, standard footprint

**Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**




FR4 PCB, mounting pad for drain 6 $cm^2$

**Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**


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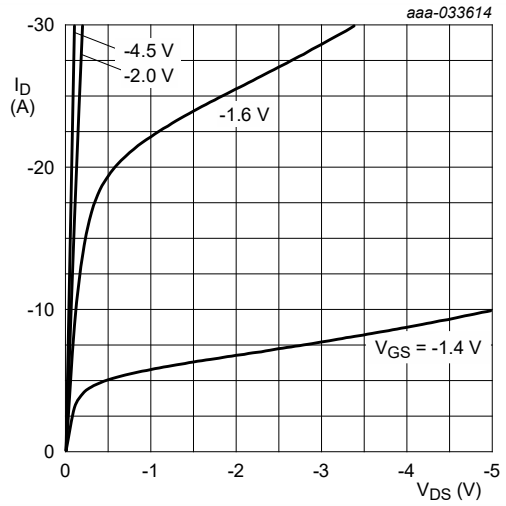
# 10. Characteristics

**Table 7. Characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **Static characteristics** | | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D$ = -250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | -12 | - | - | V |
| $V_{GSth}$ | gate-source threshold voltage | $I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$; $T_j$ = 25 °C | | -0.47 | -0.7 | -0.9 | V |
| $I_{DSS}$ | drain leakage current | $V_{DS}$ = -12 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | - | -1 | µA |
| $I_{GSS}$ | gate leakage current | $V_{GS}$ = -8 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -100 | nA |
| | | $V_{GS}$ = 8 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 100 | nA |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = -4.5 V; $I_D$ = -18.6 A; $T_j$ = 25 °C | | - | 3.2 | 3.7 | mΩ |
| | | $V_{GS}$ = -4.5 V; $I_D$ = -18.6 A; $T_j$ = 150 °C | | - | 4.4 | 5.1 | mΩ |
| | | $V_{GS}$ = -2.5 V; $I_D$ = -15.9 A; $T_j$ = 25 °C | | - | 4.1 | 5.1 | mΩ |
| | | $V_{GS}$ = -1.8 V; $I_D$ = -4 A; $T_j$ = 25 °C | | - | 6.2 | 8.5 | mΩ |
| $g_{fs}$ | forward transconductance | $V_{DS}$ = -10 V; $I_D$ = -18.6 A; $T_j$ = 25 °C | | - | 65 | - | S |
| $R_G$ | gate resistance | f = 1 MHz | | - | 4.5 | - | Ω |
| **Dynamic characteristics** | | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS}$ = -6 V; $I_D$ = -15.9 A; $V_{GS}$ = -4.5 V; $T_j$ = 25 °C | | - | 75 | 110 | nC |
| $Q_{GS}$ | gate-source charge | | | - | 9.8 | - | nC |
| $Q_{GS(th)}$ | pre-threshold gate-source charge | | | - | 4.9 | - | nC |
| $Q_{GS(th-pl)}$ | post-threshold gate-source charge | | | - | 4.9 | - | nC |
| $Q_{GD}$ | gate-drain charge | | | - | 20.5 | - | nC |
| $V_{GSpl}$ | gate-source plateau voltage | $V_{DS}$ = -6 V; $I_D$ = -15.9 A; $T_j$ = 25 °C | | - | -1.5 | - | V |
| $C_{iss}$ | input capacitance | $V_{DS}$ = -6 V; f = 1 MHz; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | 6500 | - | pF |
| $C_{oss}$ | output capacitance | | | - | 1500 | - | pF |
| $C_{rss}$ | reverse transfer capacitance | | | - | 1300 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS}$ = -6 V; $I_D$ = -15.9 A; $V_{GS}$ = -4.5 V; $R_{G(ext)}$ = 5 Ω; $T_j$ = 25 °C | | - | 8 | - | ns |
| $t_r$ | rise time | | | - | 33 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | | - | 217 | - | ns |
| $t_f$ | fall time | | | - | 177 | - | ns |
| **Source-drain diode** | | | | | | | |
| $V_{SD}$ | source-drain voltage | $I_S$ = -1.7 A; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | -0.7 | -1.2 | V |

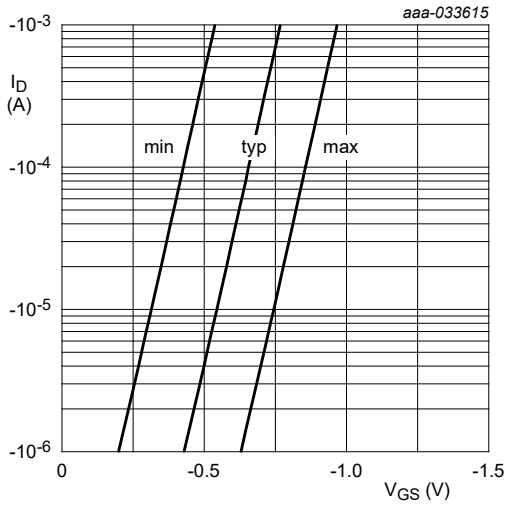

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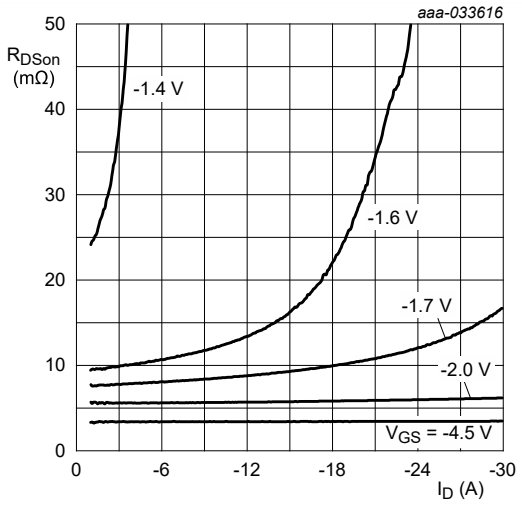

$T_j$ = 25 °C

**Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values**



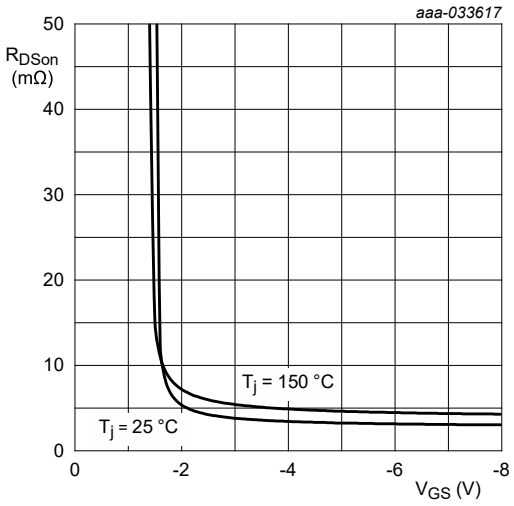

$V_{DS}$ = -5 V; $T_j$ = 25 °C

**Fig. 7. Sub-threshold drain current as a function of gate-source voltage**




$T_j$ = 25 °C

**Fig. 8. Drain-source on-state resistance as a function of drain current; typical values**

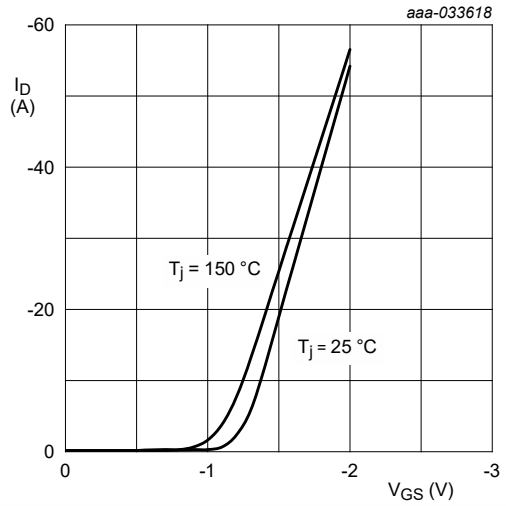



$I_D$ = -18.6 A

**Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values**

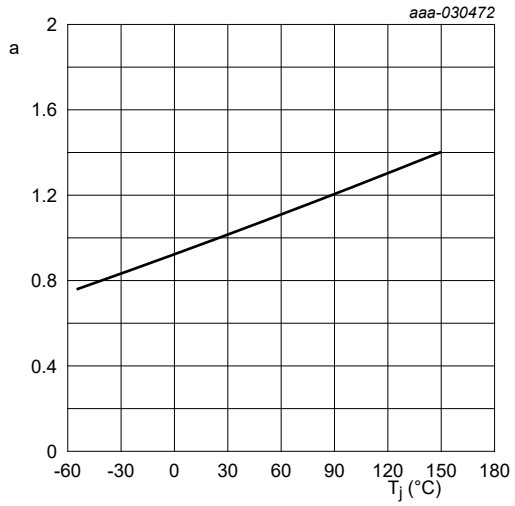

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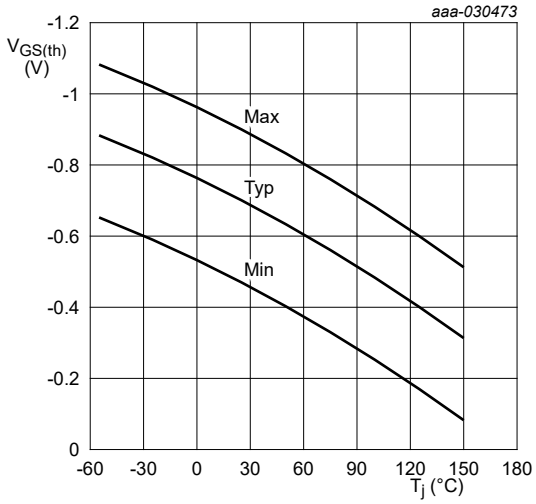

$V_{DS}$ = -5 V

**Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values**



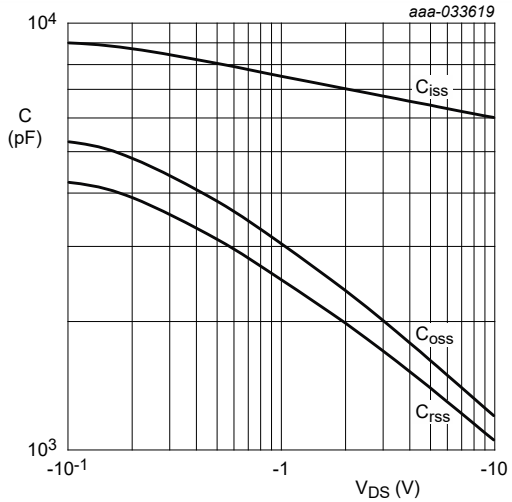

$$a = \frac{R_{DSon}}{R_{DSon\ (25°C)}}$$

**Fig. 11. Normalized drain-source on-state resistance factor as a function of junction temperature; typical values**




$I_D$ = -250 µA ; $V_{DS}$ = $V_{GS}$

**Fig. 12. Gate-source threshold voltage as a function of junction temperature**

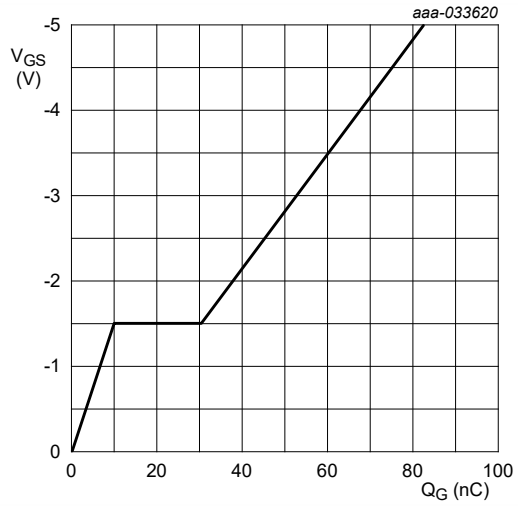



f = 1 MHz; $V_{GS}$ = 0 V

**Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**


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$V_{DS}$ = -6 V; $I_D$ = -15.9 A; $T_j$ = 25 °C

**Fig. 14. Gate-source voltage as a function of gate charge; typical values**

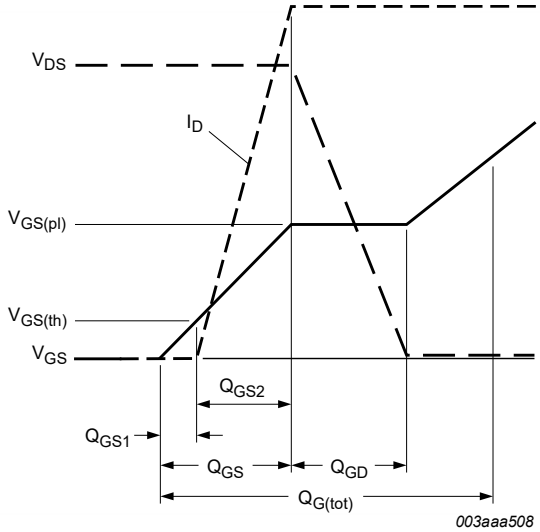
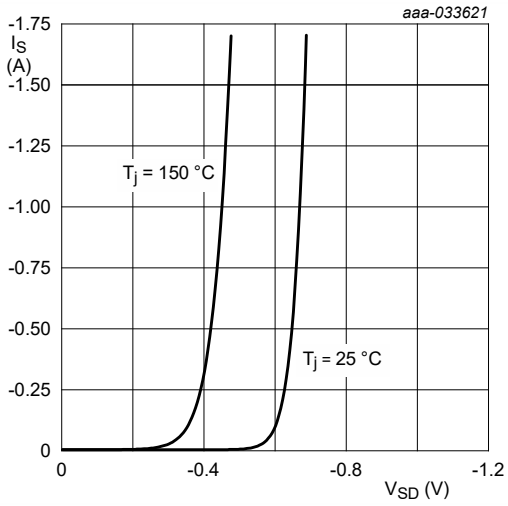



**Fig. 15. Gate charge waveform definitions**




$V_{GS}$ = 0 V

**Fig. 16. Source current as a function of source-drain voltage; typical values**

## 11. Test information

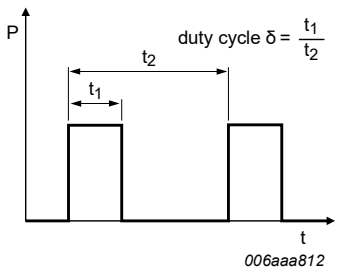


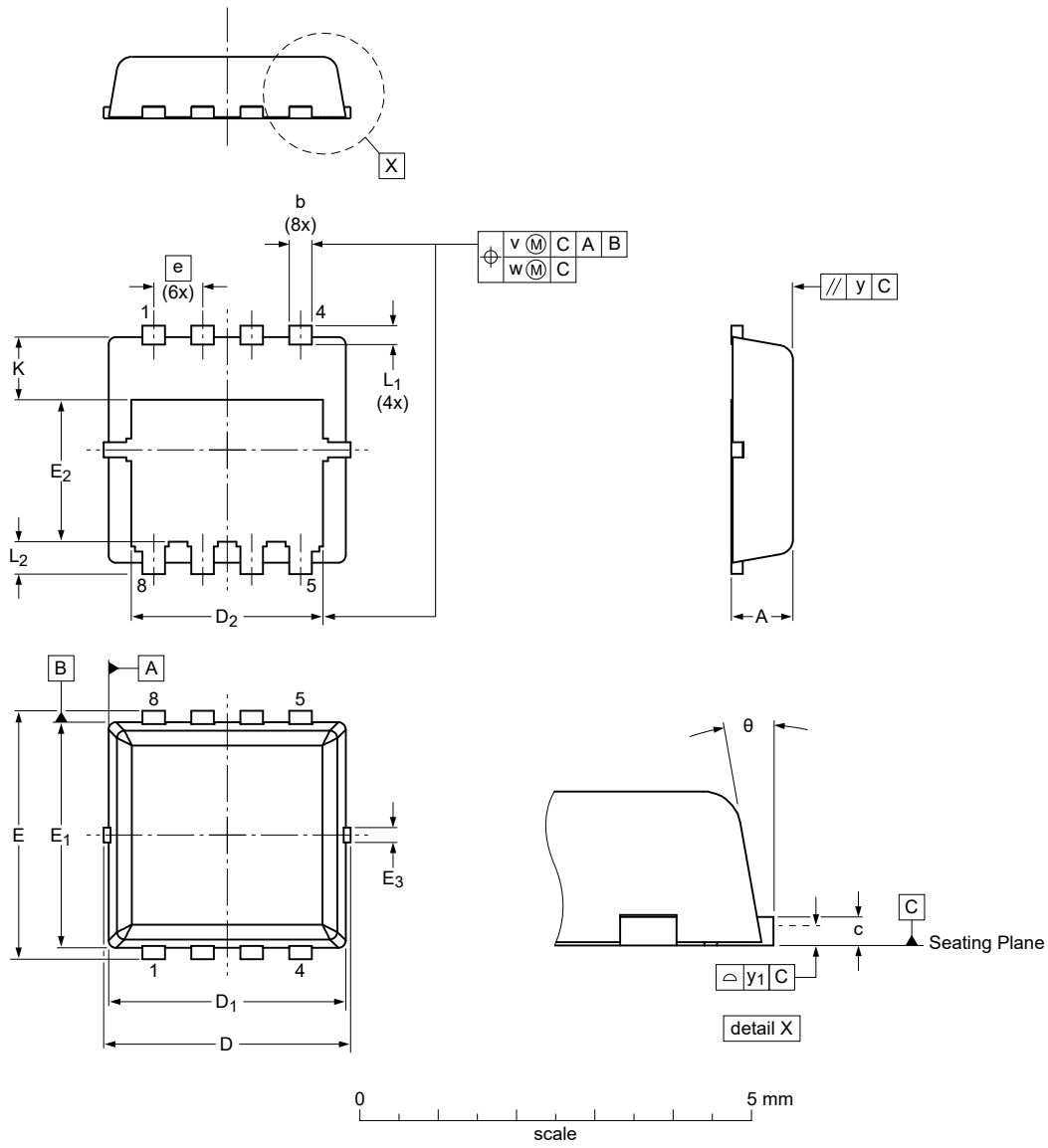

**Fig. 17. Duty cycle definition**


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## 12. Package outline

**MLPAK33: plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body** **SOT8002-1**




Dimensions (mm are the original dimensions)

| Unit | | A | b | c | D | $D_1$ | $D_2$ | e | E | $E_1$ | $E_2$ | $E_3$ | K | $L_1$ | $L_2$ | θ | y | $y_1$ | v | w |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | max | 0.90 | 0.35 | 0.18 | 3.50 | 3.25 | 2.65 | 0.65 | 3.50 | 3.10 | 1.99 | 0.25 | 0.65 (ref) | 0.40 | 0.58 | 12° | 0.05 | 0.05 | 0.1 | 0.05 |
| | nom | 0.80 | 0.30 | 0.15 | 3.30 | 3.15 | 2.55 | | 3.30 | 3.00 | 1.89 | 0.20 | | 0.25 | 0.43 | 10° | | | | |
| | min | 0.70 | 0.25 | 0.12 | 3.10 | 3.05 | 2.45 | | 3.10 | 2.90 | 1.79 | 0.15 | | 0.10 | 0.28 | 8° | | | | |

*sot8002-1_po*

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | EIAJ | | | |
| SOT8002-1 | | | | | | ~~19-12-19~~ 20-01-09 |

**Fig. 18. Package outline MLPAK33 (SOT8002-1)**


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## 13. Soldering

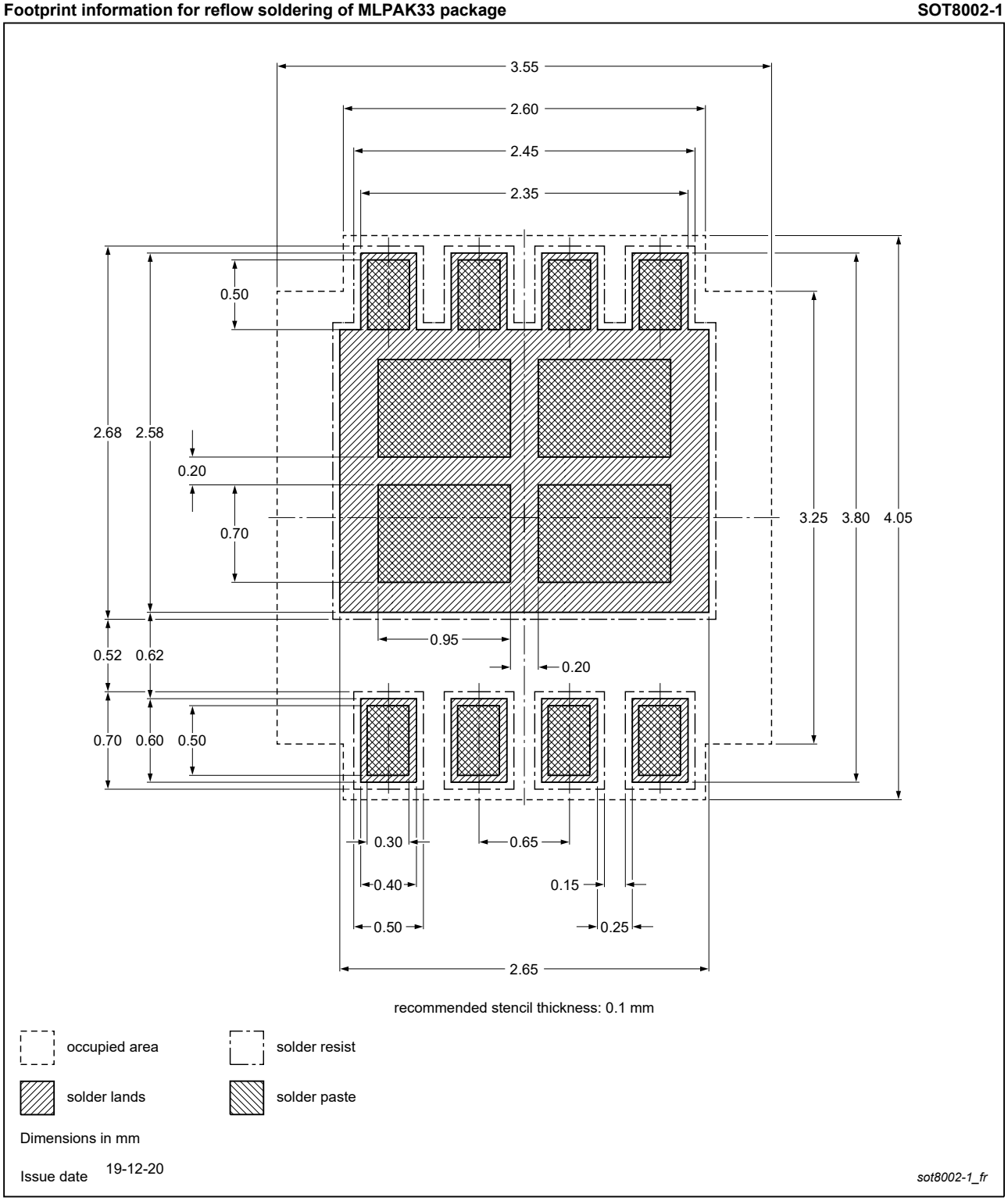



**Fig. 19. Reflow soldering footprint for MLPAK33 (SOT8002-1)**


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# 14. Revision history

**Table 8. Revision history**

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| PXP3R7-12QU v.1 | 20210906 | Product data sheet | - | - |


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## Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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